

NP0G3D2

Silicon PNP epitaxial planar transistor (Tr1)
Silicon NPN epitaxial planar transistor (Tr2)

For digital circuits

■ Features

- Two elements incorporated into one package
- Suitable for high density package and downsizing of the equipment
- Automatic insertion with the taping is possible

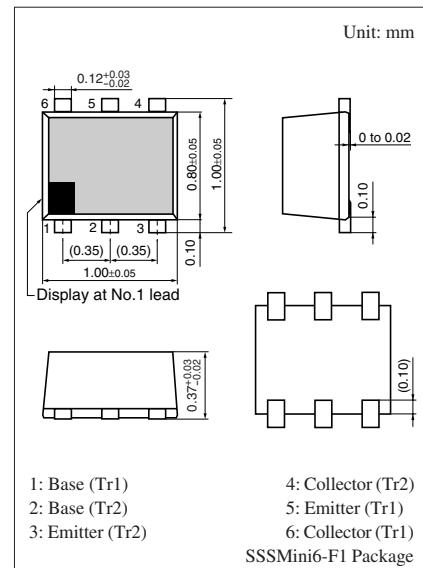
■ Basic Part Number of Element

- UNR31AT × UNR32AL

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

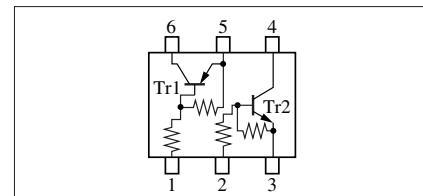
	Parameter	Symbol	Rating	Unit
Tr1	Collector to base voltage	V_{CBO}	-50	V
	Collector to emitter voltage	V_{CEO}	-50	V
	Collector current	I_C	-80	mA
Tr2	Collector to base voltage	V_{CBO}	50	V
	Collector to emitter voltage	V_{CEO}	50	V
	Collector current	I_C	80	mA
Overall	Total power dissipation *	P_T	125	mW
	Junction temperature	T_j	125	°C
	Storage temperature	T_{stg}	-55 to +125	°C

Note) *: Measuring on substrate at 17 mm × 10 mm × 1 mm



Marking Symbol: 3B

Internal Connection



■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

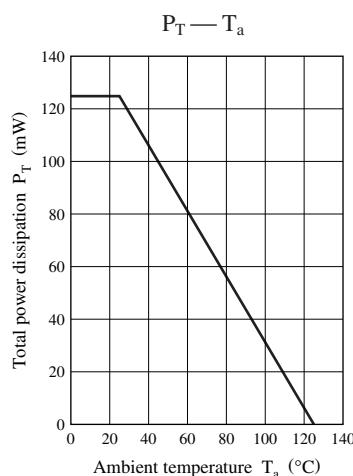
• Tr1

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector to base voltage	V_{CBO}	$I_C = -10 \mu\text{A}, I_E = 0$	-50			V
Collector to emitter voltage	V_{CEO}	$I_C = -2 \text{ mA}, I_B = 0$	-50			V
Collector cutoff current	I_{CBO}	$V_{\text{CB}} = -50 \text{ V}, I_E = 0$			-0.1	μA
	I_{CEO}	$V_{\text{CE}} = -50 \text{ V}, I_B = 0$			-0.5	
Emitter cutoff current	I_{EBO}	$V_{\text{EB}} = -6 \text{ V}, I_C = 0$			-0.2	mA
Forward current transfer ratio	h_{FE}	$V_{\text{CE}} = -10 \text{ V}, I_C = -5 \text{ mA}$	80	400		—
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	$I_C = -10 \text{ mA}, I_B = -0.3 \text{ mA}$			-0.25	V
High level output voltage	V_{OH}	$V_{\text{CC}} = -5 \text{ V}, V_B = -0.5 \text{ V}, R_L = 1 \text{ k}\Omega$	-4.9			V
Low level output voltage	V_{OL}	$V_{\text{CC}} = -5 \text{ V}, V_B = -2.5 \text{ V}, R_L = 1 \text{ k}\Omega$			-0.2	V
Input resistance	R_1		-30%	22	+30%	$\text{k}\Omega$
Resistance ratio	R_1 / R_2			0.47		—
Gain bandwidth product	f_T	$V_{\text{CB}} = -10 \text{ V}, I_E = 1 \text{ mA}, f = 200 \text{ MHz}$		80		MHz

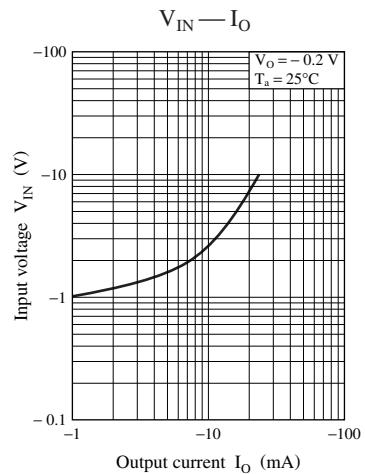
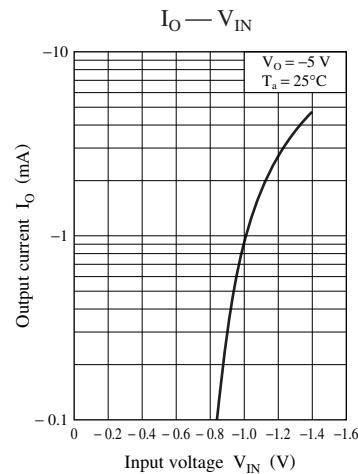
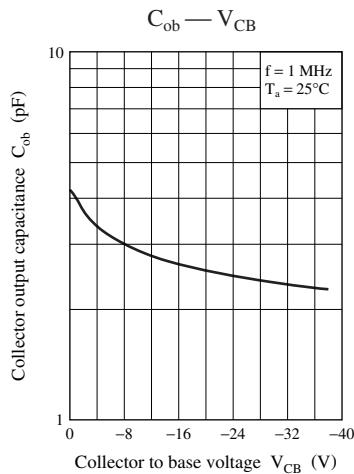
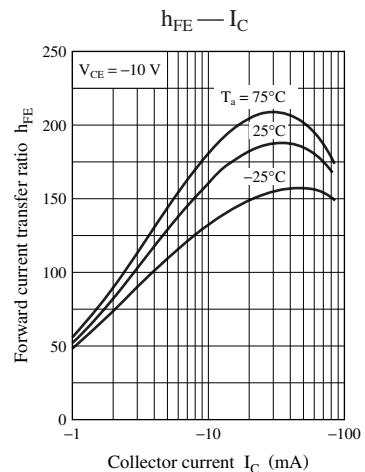
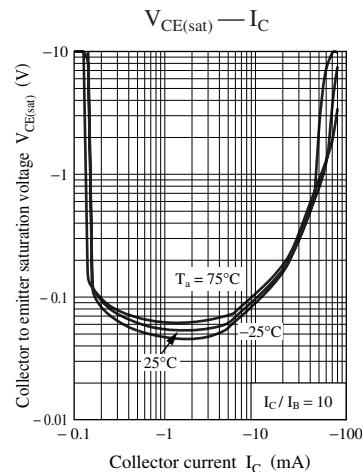
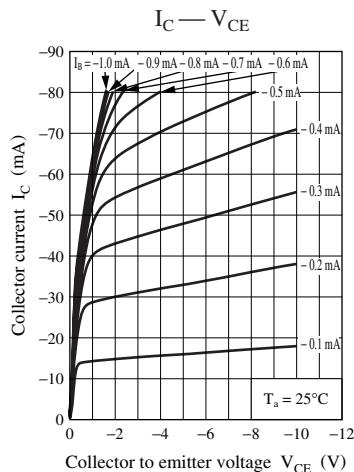
• Tr2

Parameter	Symbol	Conditions	Min	Typ	Max	Unit	
Collector to base voltage	V_{CBO}	$I_C = 10 \mu\text{A}, I_E = 0$	50			V	
Collector to emitter voltage	V_{CEO}	$I_C = 2 \text{ mA}, I_B = 0$	50			V	
Collector cutoff current	I_{CBO}	$V_{\text{CB}} = 50 \text{ V}, I_E = 0$			0.1	μA	
	I_{CEO}	$V_{\text{CE}} = 50 \text{ V}, I_B = 0$			0.5		
Emitter cutoff current	I_{EBO}	$V_{\text{EB}} = 6 \text{ V}, I_C = 0$			2.0	mA	
Forward current transfer ratio	h_{FE}	$V_{\text{CE}} = 10 \text{ V}, I_C = 5 \text{ mA}$	20			—	
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	$I_C = 10 \text{ mA}, I_B = 0.3 \text{ mA}$			0.25	V	
High level output voltage	V_{OH}	$V_{\text{CC}} = 5 \text{ V}, V_B = 0.5 \text{ V}, R_L = 1 \text{ k}\Omega$	4.9			V	
Low level output voltage	V_{OL}	$V_{\text{CC}} = 5 \text{ V}, V_B = 2.5 \text{ V}, R_L = 1 \text{ k}\Omega$			0.2	V	
Input resistance	R_1		-30%	4.7	+30%	$\text{k}\Omega$	
Resistance ratio	R_1 / R_2			0.8	1.0	1.2	—
Gain bandwidth product	f_T	$V_{\text{CB}} = 10 \text{ V}, I_E = -2 \text{ mA}, f = 200 \text{ MHz}$		150		MHz	

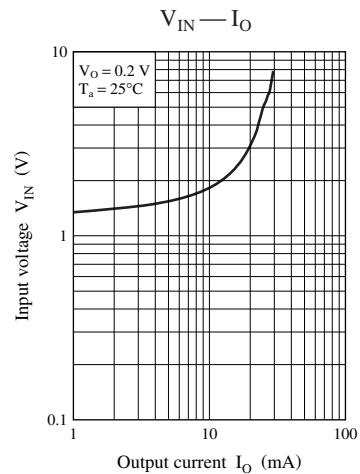
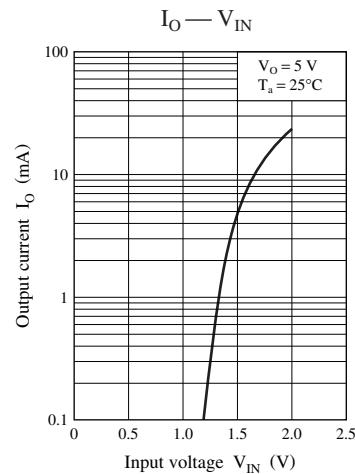
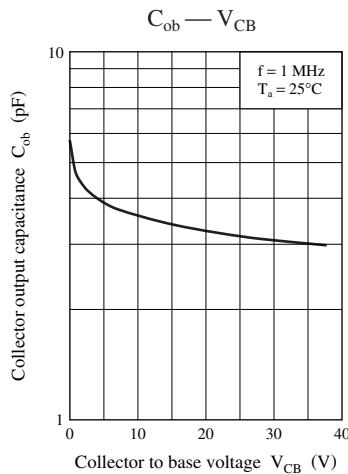
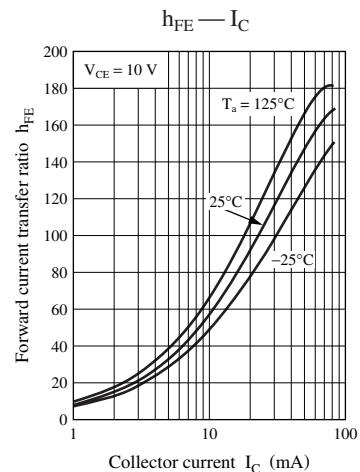
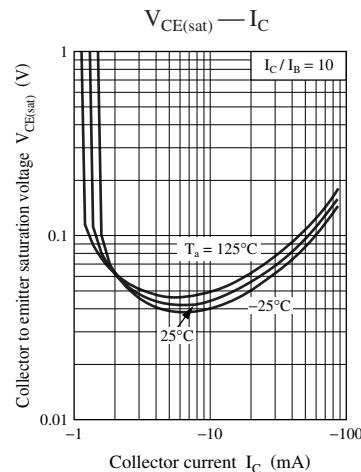
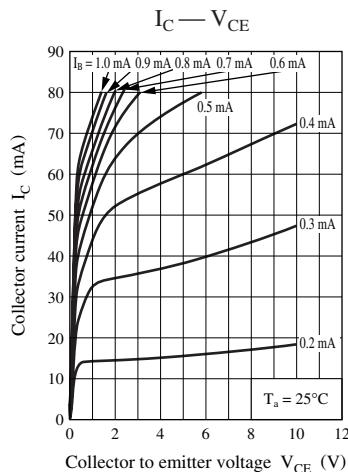
Common characteristics chart



Characteristics charts of Tr1



Characteristics charts of Tr2



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